



WCN Opto Group Co., Limited

WCN-8808B7-DA04

SPECIFICATION

WCN			CUSTOMER Confirmed
Prepared by	Checked by	Approved by	
Fei 2016-3-26	Athena		
REVISION RECORD			



REVISION: A0

WCN Opto Group Co., Limited

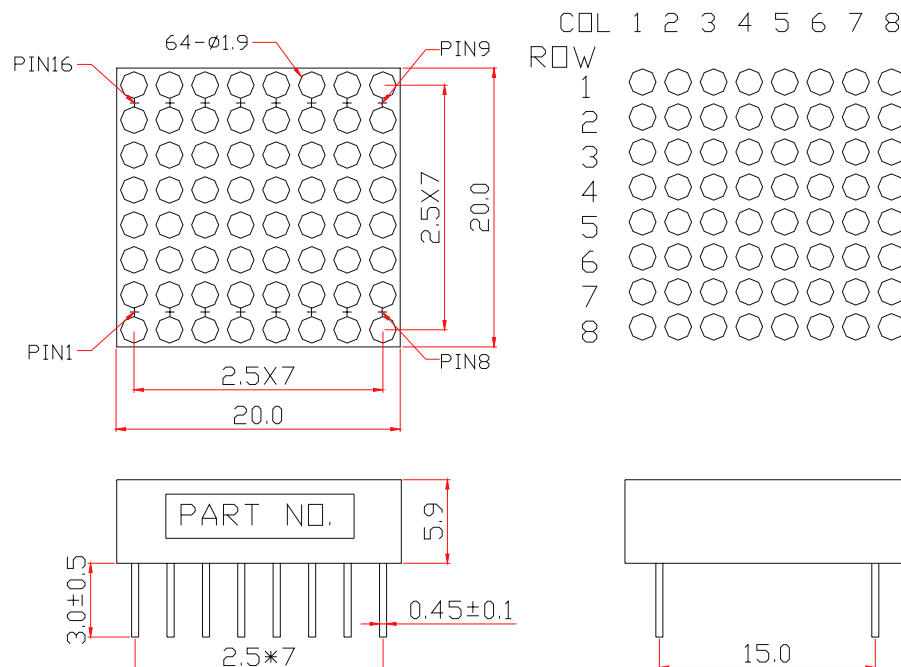
Features:

- High Reliability
- Color: Blue
- Low Power Requirement
- Flat Package and Light Weight
- Easy Assembly

Description:

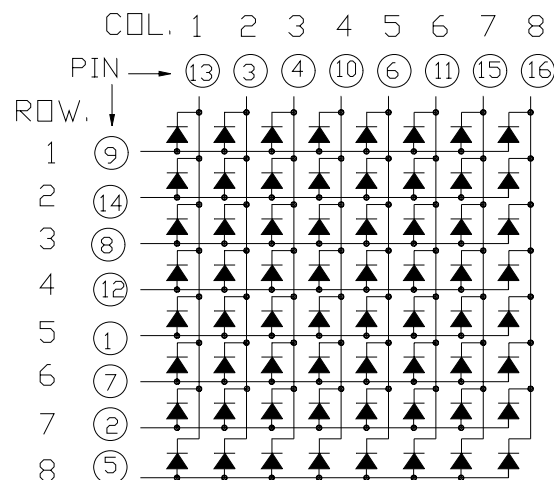
- 8*8 LED Dot Matrix
- ϕ 1.9 mm Dot and Pitch 2.50 mm
- Black Face and Milky Dots

Outer Dimension:



Notes : Unless otherwise stated, The tolerance is ± 0.25 mm.

Circuit Diagram





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■ Absolute Maximum Rating (Ta=25°C) / Per Dice:

Parameter	Symbol	Condition	Color	Rating	Units
Maximal Power Dissipation (When completely Lighting)	P _d	—	Blue	90	mW
Maximal Forward Current (When completely Lighting)	I _F	—	Blue	25	mA
Peak Forward Current	I _{FP}	1/8Duty 10khz	Blue	100	mA
Reverse Voltage	V _R	—	Blue	5	V
Operating Temperature Range	Topr	—	—	-40~+85	°C
Storage Temperature Range	Tstg	—	—	-40~+85	°C

■ Electrical/Optical Characteristics Rating(Ta=25°C)

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V _F	I _F =20mA	Per Dice	2.60	3.2	3.60	V
Reverse Current	I _R	V _R =5V	Per Dice	—	—	100	μA
Luminous Intensity	I _V	I _F =10mA	Per Dice	6.1	9.5	15.25	mcd
Wave Length	λ _p	I _F =20mA	Per Dice	—	465	—	nm
	λ _d				470		
Spectral Line Half Width	△λ	I _F =20mA	Per Dice	—	20	—	nm
Luminous Intensity Matching Ratio (Dot To Dot)	I _{V-M}	1/8Duty I _{FP} =40mA				1.2:1	

■ Luminous Intensity Sorting (1/8Duty ; I_{FP} =40mA ; The Tolerance is +/-10%)

BIN Color	N	O	P	Q	R
Blue (mcd)	6.101-7.20	7.201-8.50	8.501-10.5	10.501-12.8	12.801-15.250

■ Soldering Conditions: Soldering Temp. ≤+260°C

Soldering Time. ≤3sec.

(at 2mm Distance from The Case of Reflector Edge)

■ Typical Elector-Optical Characteristics Curve:

Fig1. Forward Current vs. Forward Voltage:

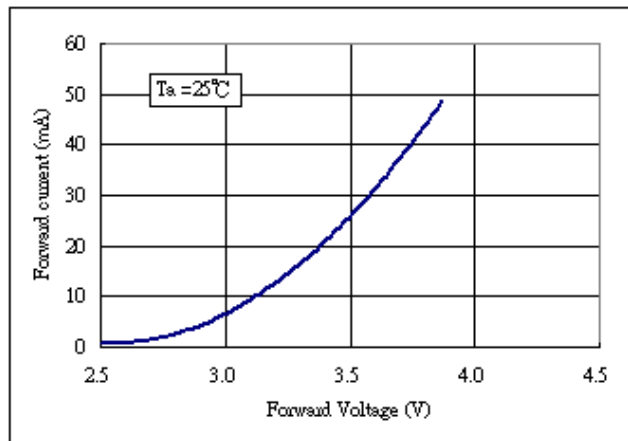


Fig2. Forward Current vs. Relative Intensity:

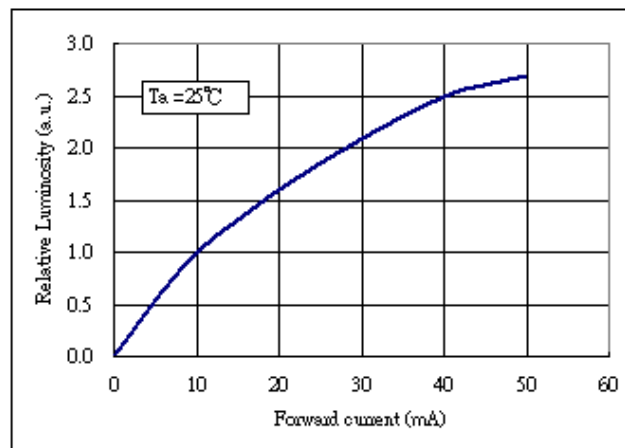


Fig3. Forward Current vs. Relative Wavelength:

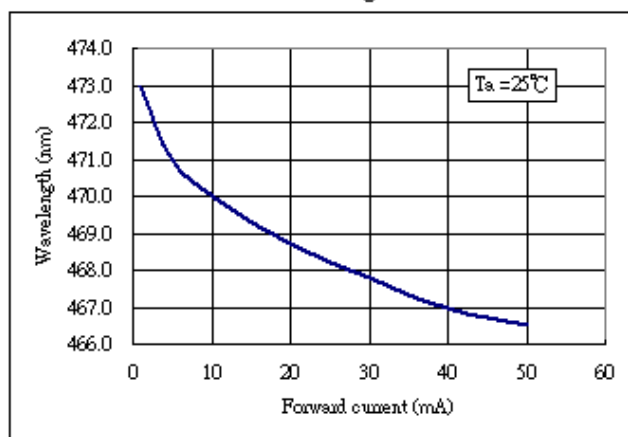
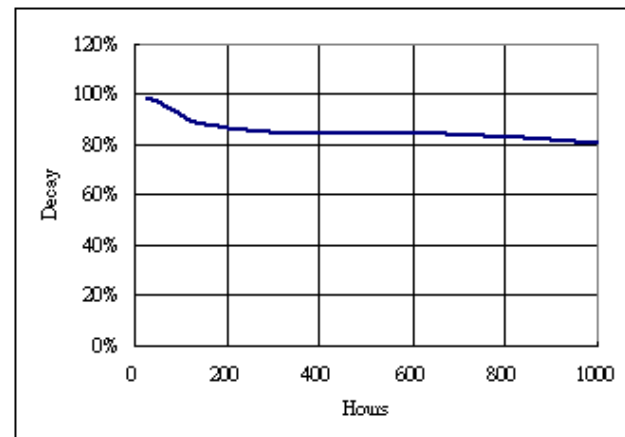


Fig4. Life Test at 20mA R.T. 1000hrs:



LED Displays Reliability Test:

CLASSIFICATION	TEST ITEM	DESCRIPTION AND TEST CONDITION
ENDURANCE TEST	OPERATION LIFE	EVALUATES RESISTANCE OF THE DEVICE WHEN OPERATED AT ELECTRICAL STRESS T_a = UNDER ROOM TEMPERATURE $I_F = I_F \text{ max}$
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	EVALUATES MOISTURE RESISTANCE OF THE DEVICE WHEN STORED FOR A LONG TERM AT HIGH TEMPERATURE AND HUMIDITY $T_a = 65 \pm 5^\circ\text{C}$ RH=90~95%RH TEST TIME=240 $\pm$ 2Hrs
	HIGH TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN HIGH TEMPERATURE $T_a = 85 \pm 5^\circ\text{C}$ (COB: $T_a = 65 \pm 5^\circ\text{C}$) TEST TIME=1000Hrs(-24Hrs, +72Hrs)
	LOW TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN LOW TEMPERATURE $T_a = -35 \pm 5^\circ\text{C}$ TEST TIME=1000Hrs(-24Hrs, +72Hrs)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	EVALUATES RESISTANCE OF DEVICE AT THERMAL STRESSES OR EXPANSION AND CONTRACTION $85^\circ\text{C} \sim 25^\circ\text{C} \sim -35^\circ\text{C} \sim 25^\circ\text{C}$ 30min 5min 30min 5min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$, $T_{\text{cold}}=-25^\circ\text{C}$)
	THERMAL SHOCK	EVALUATES DEVICE STRUCTURE AND STRUCTURE AND MECHANICAL RESISTANCE WHEN SUDDENLY EXPOSED AT SERVE CHANGES $85 \pm 5^\circ\text{C} \sim -35 \pm 5^\circ\text{C}$ 10min 10min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$, $T_{\text{cold}}=-25^\circ\text{C}$)
	SOLDERABILITY	EVALUATES SOLDERABILITY ON LEADS OF DEVICE $T_{\text{SOL}}=230 \pm 5^\circ\text{C}$ DWELL TIME=5 $\pm$ 1sec.
	SOLDER RESISTANCE	EVALUATES RESISTANCE TO THERMAL STRESS CAUSED BY SOLDERING $T_{\text{SOL}}=260 \pm 5^\circ\text{C}$ DWELL TIME=10 $\pm$ 1sec.

Packing method A:

112 pcs / Expandable Polyethylene.

780 pcs / Box(360*175*130mm).

4680 pcs / Catton(550*380*280mm).